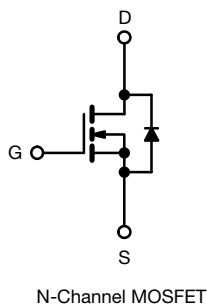


## E Series Power MOSFET

**Thin-Lead TO-220 FULLPAK**


### FEATURES

- Low figure-of-merit (FOM)  $R_{on} \times Q_g$
- Low input capacitance ( $C_{iss}$ )
- Reduced switching and conduction losses
- Low gate charge ( $Q_g$ )
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
**HALOGEN**  
**FREE**  
Available

### APPLICATIONS

- Computing
  - PC silver box / ATX power supplies
- Lighting
  - Two stage LED lighting
- Consumer electronics
- Applications using hard switched topologies
  - Power factor correction (PFC)
  - Two switch forward converter
  - Flyback converter
- Switch mode power supplies (SMPS)

### PRODUCT SUMMARY

|                                         |                 |       |
|-----------------------------------------|-----------------|-------|
| $V_{DS}$ (V) at $T_J$ max.              | 550             |       |
| $R_{DS(on)}$ max. ( $\Omega$ ) at 25 °C | $V_{GS} = 10$ V | 0.380 |
| $Q_g$ max. (nC)                         | 50              |       |
| $Q_{gs}$ (nC)                           | 6               |       |
| $Q_{gd}$ (nC)                           | 10              |       |
| Configuration                           | Single          |       |

### ORDERING INFORMATION

|                                 |                          |
|---------------------------------|--------------------------|
| Package                         | Thin-Lead TO-220 FULLPAK |
| Lead (Pb)-free                  | SiHA12N50E-E3            |
| Lead (Pb)-free and halogen-free | SiHA12N50E-GE3           |

### ABSOLUTE MAXIMUM RATINGS ( $T_C = 25$ °C, unless otherwise noted)

| PARAMETER                                                       |                                               |                         | SYMBOL                            | LIMIT       | UNIT |
|-----------------------------------------------------------------|-----------------------------------------------|-------------------------|-----------------------------------|-------------|------|
| Drain-source voltage                                            |                                               |                         | V <sub>DS</sub>                   | 500         | V    |
| Gate-source voltage                                             |                                               |                         | V <sub>GS</sub>                   | ± 30        |      |
| Continuous drain current (T <sub>J</sub> = 150 °C) <sup>e</sup> | V <sub>GS</sub> at 10 V                       | T <sub>C</sub> = 25 °C  | I <sub>D</sub>                    | 10.5        | A    |
|                                                                 |                                               | T <sub>C</sub> = 100 °C |                                   | 6.6         |      |
| Pulsed drain current <sup>a</sup>                               |                                               |                         | I <sub>DM</sub>                   | 21          |      |
| Linear derating factor                                          |                                               |                         |                                   | 0.91        | W/°C |
| Single pulse avalanche energy <sup>b</sup>                      |                                               |                         | E <sub>AS</sub>                   | 103         | mJ   |
| Maximum power dissipation                                       |                                               |                         | P <sub>D</sub>                    | 32          | W    |
| Operating junction and storage temperature range                |                                               |                         | T <sub>J</sub> , T <sub>stg</sub> | -55 to +150 | °C   |
| Drain-source voltage slope                                      | V <sub>DS</sub> = 0 V to 80 % V <sub>DS</sub> |                         | dV/dt                             | 70          | V/ns |
| Reverse diode dV/dt <sup>d</sup>                                |                                               |                         |                                   | 27          |      |
| Soldering recommendations (peak temperature) <sup>c</sup>       | for 10 s                                      |                         |                                   | 300         | °C   |
| Mounting torque                                                 | M3 screw                                      |                         |                                   | 0.6         | Nm   |

#### Notes

- Repetitive rating; pulse width limited by maximum junction temperature
- $V_{DS} = 50$  V, starting  $T_J = 25$  °C,  $L = 28.2$  mH,  $R_g = 25$   $\Omega$ ,  $I_{AS} = 2.7$  A
- 1.6 mm from case
- $I_{SD} \leq I_D$ ,  $dI/dt = 100$  A/ $\mu$ s, starting  $T_J = 25$  °C
- Limited by maximum junction temperature

**THERMAL RESISTANCE RATINGS**

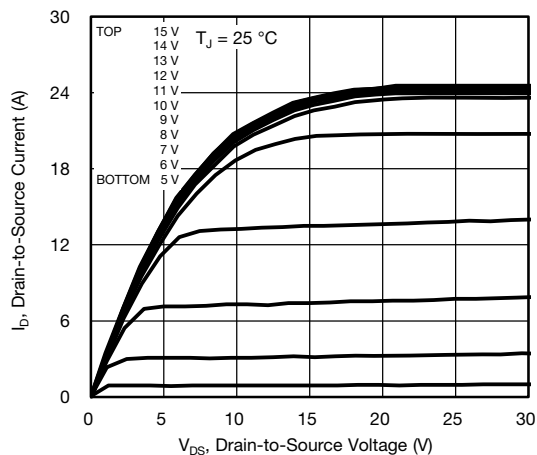
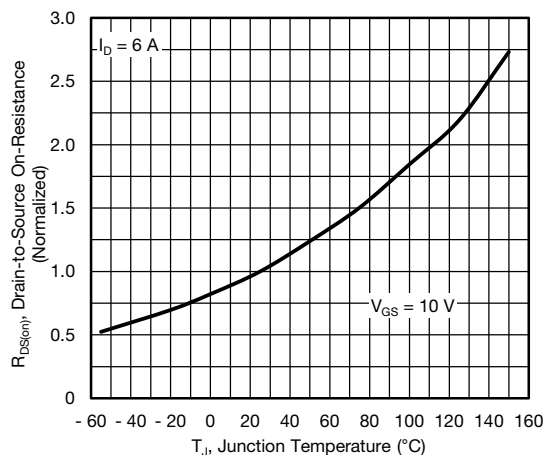
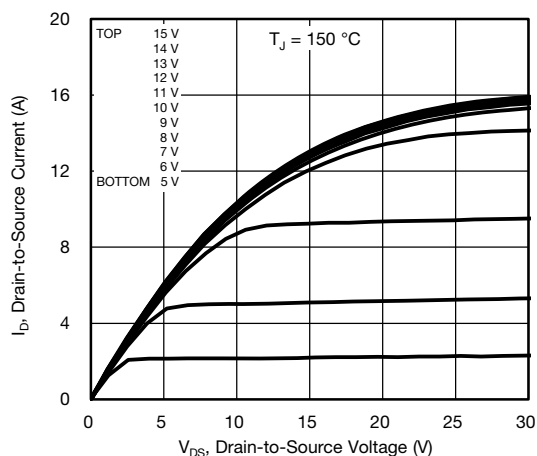
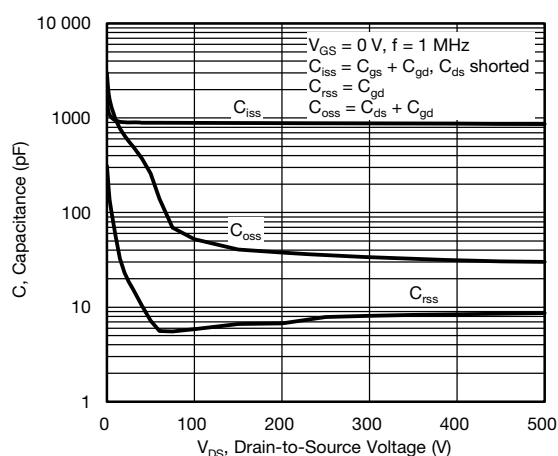
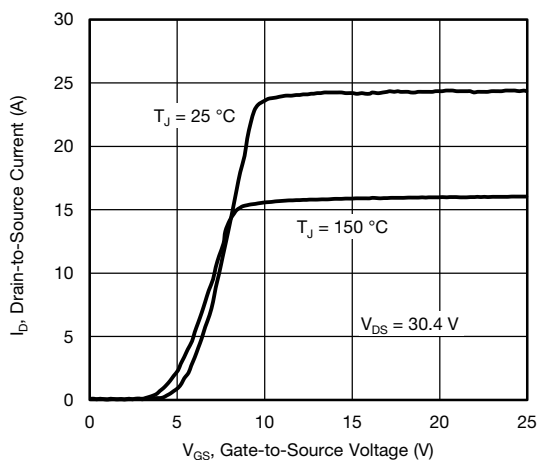
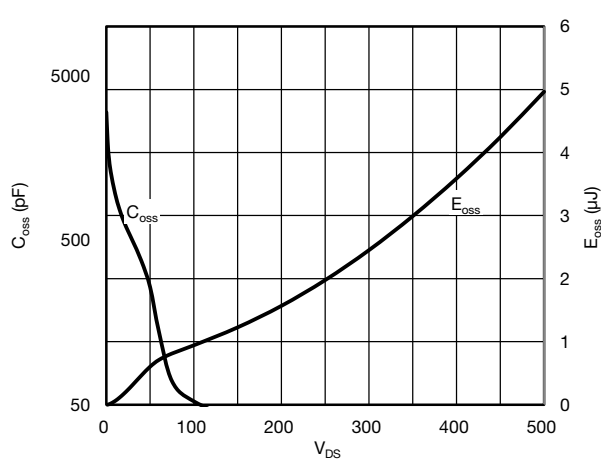
| PARAMETER                        | SYMBOL     | TYP. | MAX. | UNIT |
|----------------------------------|------------|------|------|------|
| Maximum junction-to-ambient      | $R_{thJA}$ | -    | 65   | °C/W |
| Maximum junction-to-case (drain) | $R_{thJC}$ | -    | 3.9  |      |

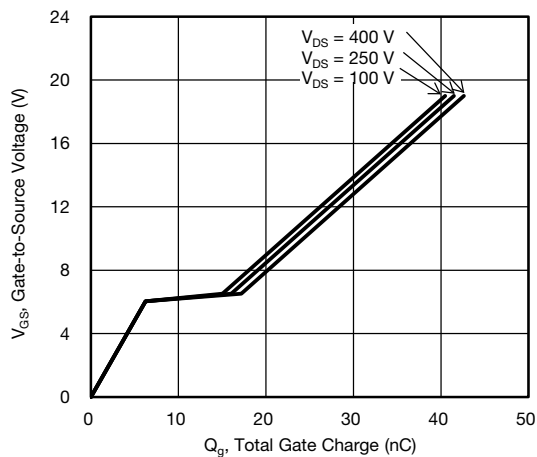
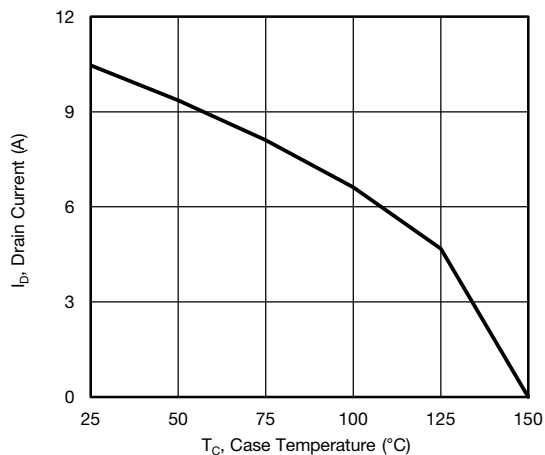
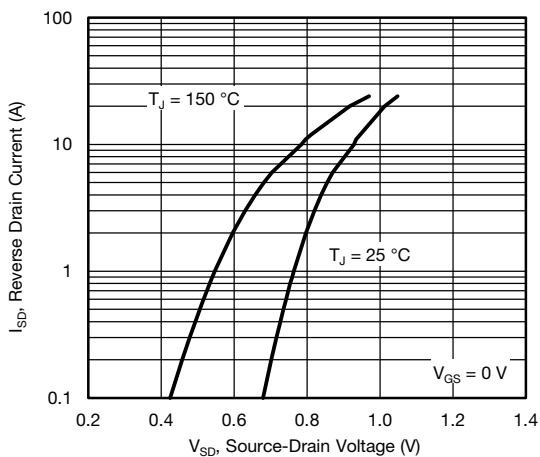
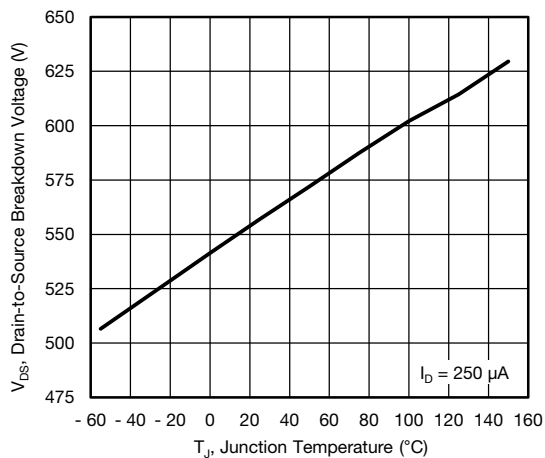
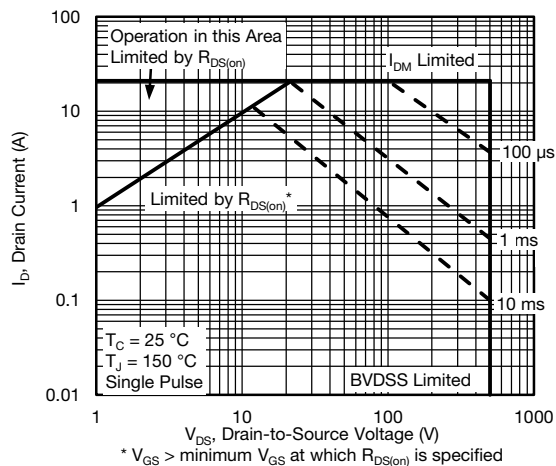
**SPECIFICATIONS** ( $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted)

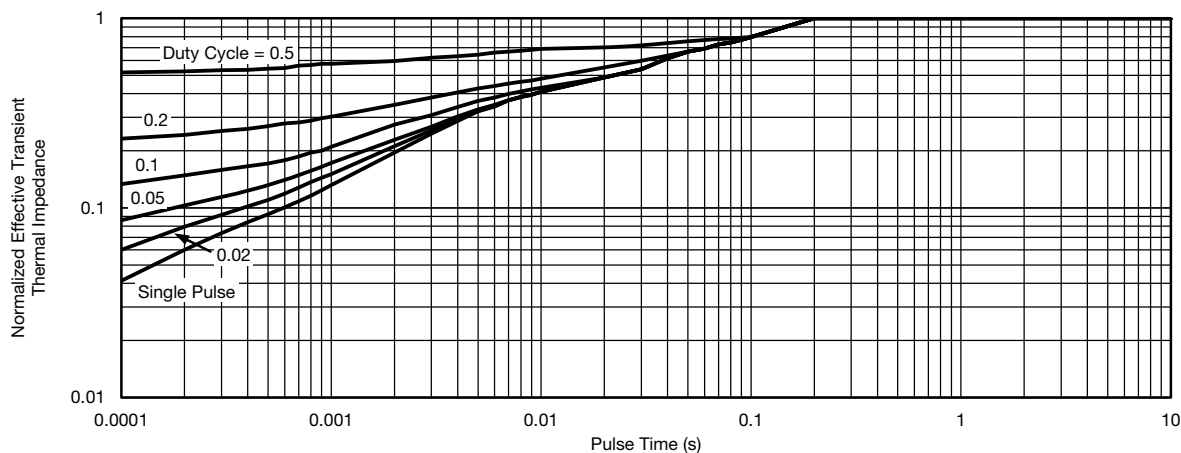
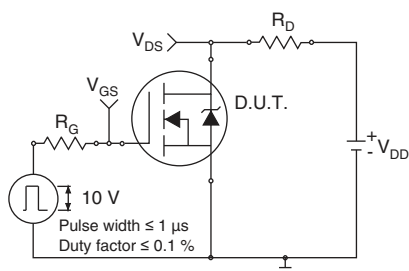
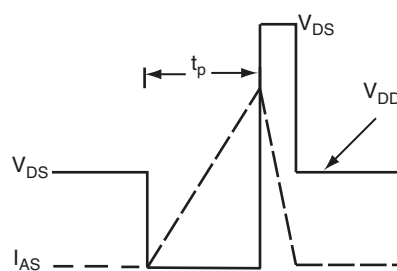
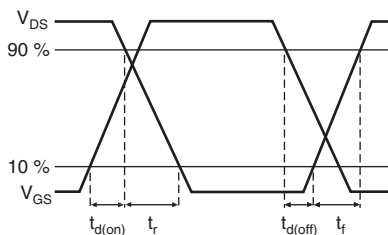
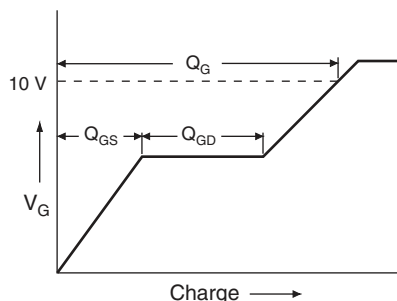
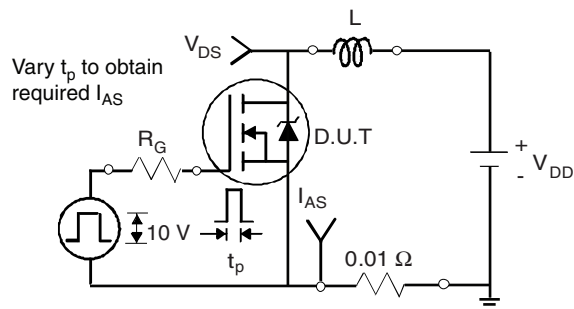
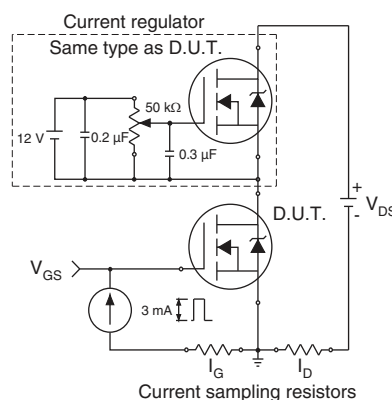
| PARAMETER                                                 | SYMBOL              | TEST CONDITIONS                                                                                                                                          |                                              | MIN. | TYP.  | MAX.      | UNIT          |
|-----------------------------------------------------------|---------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------|------|-------|-----------|---------------|
| Static                                                    |                     |                                                                                                                                                          |                                              |      |       |           |               |
| Drain-source breakdown voltage                            | $V_{DS}$            | $V_{GS} = 0\text{ V}$ , $I_D = 250\text{ }\mu\text{A}$                                                                                                   |                                              | 500  | -     | -         | V             |
| $V_{DS}$ temperature coefficient                          | $\Delta V_{DS}/T_J$ | Reference to $25\text{ }^\circ\text{C}$ , $I_D = 1\text{ mA}$                                                                                            |                                              | -    | 0.60  | -         | V/°C          |
| Gate-source threshold voltage (N)                         | $V_{GS(th)}$        | $V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$                                                                                                       |                                              | 2.0  | -     | 4.0       | V             |
| Gate-source leakage                                       | $I_{GSS}$           | $V_{GS} = \pm 20\text{ V}$                                                                                                                               |                                              | -    | -     | $\pm 100$ | nA            |
|                                                           |                     | $V_{GS} = \pm 30\text{ V}$                                                                                                                               |                                              | -    | -     | $\pm 1$   | $\mu\text{A}$ |
| Zero gate voltage drain current                           | $I_{DSS}$           | $V_{DS} = 500\text{ V}$ , $V_{GS} = 0\text{ V}$                                                                                                          |                                              | -    | -     | 1         | $\mu\text{A}$ |
|                                                           |                     | $V_{DS} = 400\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 125\text{ }^\circ\text{C}$                                                                      |                                              | -    | -     | 10        |               |
| Drain-source on-state resistance                          | $R_{DS(on)}$        | $V_{GS} = 10\text{ V}$                                                                                                                                   | $I_D = 6\text{ A}$                           | -    | 0.330 | 0.380     | $\Omega$      |
| Forward transconductance                                  | $g_{fs}$            | $V_{DS} = 30\text{ V}$ , $I_D = 6\text{ A}$                                                                                                              |                                              | -    | 3.1   | -         | S             |
| Dynamic                                                   |                     |                                                                                                                                                          |                                              |      |       |           |               |
| Input capacitance                                         | $C_{iss}$           | $V_{GS} = 0\text{ V}$ ,<br>$V_{DS} = 100\text{ V}$ ,<br>$f = 1\text{ MHz}$                                                                               |                                              | -    | 886   | -         | pF            |
| Output capacitance                                        | $C_{oss}$           |                                                                                                                                                          |                                              | -    | 52    | -         |               |
| Reverse transfer capacitance                              | $C_{rss}$           |                                                                                                                                                          |                                              | -    | 6     | -         |               |
| Effective output capacitance, energy related <sup>a</sup> | $C_{o(er)}$         | $V_{DS} = 0\text{ V to } 400\text{ V}$ , $V_{GS} = 0\text{ V}$                                                                                           |                                              | -    | 45    | -         |               |
| Effective output capacitance, time related <sup>b</sup>   | $C_{o(tr)}$         |                                                                                                                                                          |                                              | -    | 131   | -         |               |
| Total gate charge                                         | $Q_g$               | $V_{GS} = 10\text{ V}$                                                                                                                                   | $I_D = 6\text{ A}$ , $V_{DS} = 400\text{ V}$ | -    | 25    | 50        | nC            |
| Gate-source charge                                        | $Q_{gs}$            |                                                                                                                                                          |                                              | -    | 6     | -         |               |
| Gate-drain charge                                         | $Q_{gd}$            |                                                                                                                                                          |                                              | -    | 10    | -         |               |
| Turn-on delay time                                        | $t_{d(on)}$         | $V_{DD} = 400\text{ V}$ , $I_D = 6\text{ A}$ ,<br>$V_{GS} = 10\text{ V}$ , $R_g = 9.1\text{ }\Omega$                                                     |                                              | -    | 13    | 26        | ns            |
| Rise time                                                 | $t_r$               |                                                                                                                                                          |                                              | -    | 16    | 32        |               |
| Turn-off delay time                                       | $t_{d(off)}$        |                                                                                                                                                          |                                              | -    | 29    | 58        |               |
| Fall time                                                 | $t_f$               |                                                                                                                                                          |                                              | -    | 12    | 24        |               |
| Gate input resistance                                     | $R_g$               | $f = 1\text{ MHz}$ , open drain                                                                                                                          |                                              | -    | 0.92  | -         | $\Omega$      |
| Drain-Source Body Diode Characteristics                   |                     |                                                                                                                                                          |                                              |      |       |           |               |
| Continuous source-drain diode current                     | $I_S$               | MOSFET symbol showing the integral reverse p - n junction diode<br> |                                              | -    | -     | 10.5      | A             |
| Pulsed diode forward current                              | $I_{SM}$            |                                                                                                                                                          |                                              | -    | -     | 21        |               |
| Diode forward voltage                                     | $V_{SD}$            | $T_J = 25\text{ }^\circ\text{C}$ , $I_S = 7.5\text{ A}$ , $V_{GS} = 0\text{ V}$                                                                          |                                              | -    | -     | 1.2       | V             |
| Reverse recovery time                                     | $t_{rr}$            | $T_J = 25\text{ }^\circ\text{C}$ , $I_F = I_S = 6\text{ A}$ ,<br>$dI/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 25\text{ V}$                                |                                              | -    | 244   | -         | ns            |
| Reverse recovery charge                                   | $Q_{rr}$            |                                                                                                                                                          |                                              | -    | 2.5   | -         | $\mu\text{C}$ |
| Reverse recovery current                                  | $I_{RRM}$           |                                                                                                                                                          |                                              | -    | 19    | -         | A             |

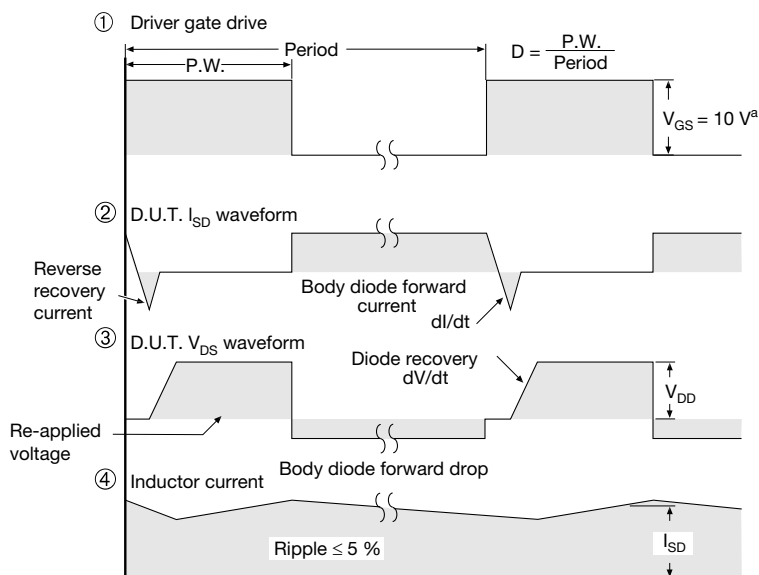
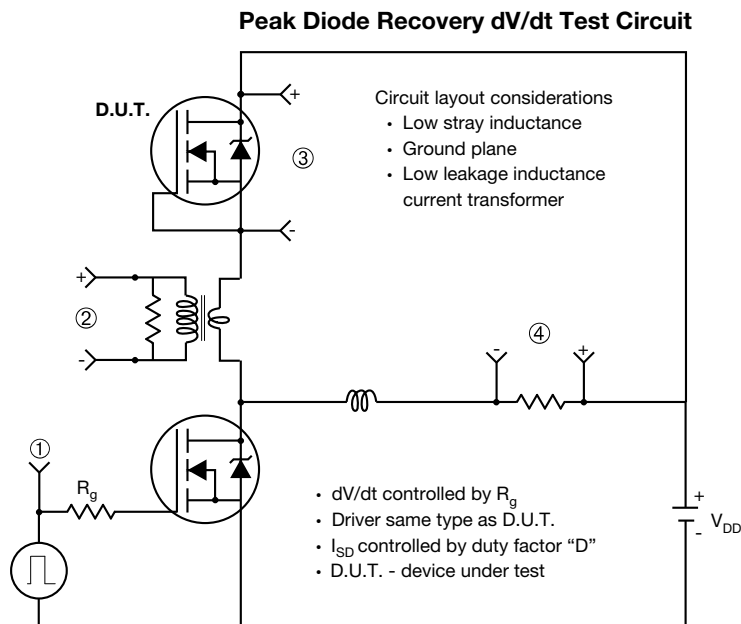
**Notes**

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$   
b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

**Fig. 1 - Typical Output Characteristics**

**Fig. 4 - Normalized On-Resistance vs. Temperature**

**Fig. 2 - Typical Output Characteristics**

**Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage**

**Fig. 3 - Typical Transfer Characteristics**

**Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $V_{DS}$**


**Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage**

**Fig. 10 - Maximum Drain Current vs. Case Temperature**

**Fig. 8 - Typical Source-Drain Diode Forward Voltage**

**Fig. 11 - Temperature vs. Drain-to-Source Voltage**

**Fig. 9 - Maximum Safe Operating Area**


**Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case**

**Fig. 13 - Switching Time Test Circuit**

**Fig. 16 - Unclamped Inductive Waveforms**

**Fig. 14 - Switching Time Waveforms**

**Fig. 17 - Basic Gate Charge Waveform**

**Fig. 15 - Unclamped Inductive Test Circuit**

**Fig. 18 - Gate Charge Test Circuit**

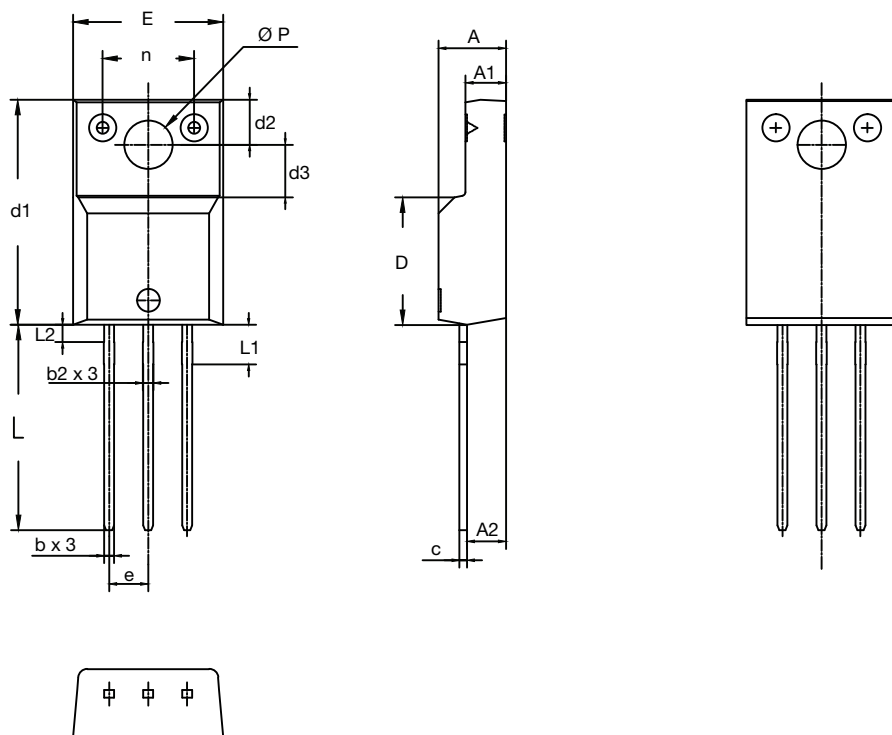

**Note**

a.  $V_{GS} = 5\text{ V}$  for logic level devices

**Fig. 19 - For N-Channel**

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## TO-220 FULLPAK Thin Lead



| SYMBOL                                       | DIMENSIONS  |       |        |       |
|----------------------------------------------|-------------|-------|--------|-------|
|                                              | MILLIMETERS |       | INCHES |       |
|                                              | MIN.        | MAX.  | MIN.   | MAX.  |
| A                                            | 4.30        | 4.70  | 0.169  | 0.185 |
| A1                                           | 2.50        | 2.90  | 0.098  | 0.114 |
| A2                                           | 2.50        | 2.70  | 0.098  | 0.106 |
| b                                            | 0.60        | 0.80  | 0.024  | 0.031 |
| b2                                           | 0.60        | 0.90  | 0.024  | 0.035 |
| c                                            | -           | 0.60  | -      | 0.024 |
| D                                            | 8.30        | 8.70  | 0.327  | 0.342 |
| d1                                           | 14.70       | 15.30 | 0.579  | 0.602 |
| d2                                           | 2.90        | 3.10  | 0.114  | 0.122 |
| d3                                           | 3.40        | 3.60  | 0.134  | 0.142 |
| E                                            | 9.70        | 10.30 | 0.382  | 0.406 |
| e                                            | 2.50        | 2.70  | 0.098  | 0.106 |
| L                                            | 13.40       | 13.80 | 0.528  | 0.543 |
| L1                                           | 2.50        | 2.80  | 0.098  | 0.110 |
| L2                                           | -           | 1.20  | -      | 0.047 |
| n                                            | 6.05        | 6.15  | 0.238  | 0.242 |
| Ø P                                          | 3.00        | 3.40  | 0.118  | 0.134 |
| ECN: T16-0549-Rev. C, 12-Sep-16<br>DWG: 6021 |             |       |        |       |



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